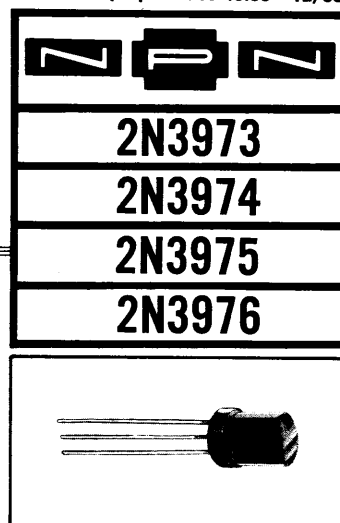


Silicon Switching TRANSISTORS

PLANAR EPITAXIAL PASSIVATED

45.66 7/66
(Supersedes 45.66 12/65)



The General Electric 2N3973-2N3976 planar epitaxial passivated NPN silicon transistors are designed primarily for medium speed industrial switching and large signal R.F. amplifiers. They feature excellent h_{FE} holdup at collector currents between 0.1 mA and 500 mA, adequate switching times for 2 MHz saturated logic circuits, and 350 MHz typical gain bandwidth product.

absolute maximum ratings: (25°C) (unless otherwise specified)

VOLTAGES

Collector to Emitter	V_{CEO}	30 Volts
Collector to Emitter	V_{CES}	40 Volts
Emitter to Base	V_{EBO}	5 Volts
Collector to Base	V_{CBO}	60 Volts

FEATURES

Low Cost
Low Saturation Voltage
High Current

CURRENT

Collector (Steady State)*	I_C	400 mA
---------------------------	-------	--------

DISSIPATION

Total Power (Free Air @ 25°C)*	P_T	360 mW
Total Power (Free Air @ 65°C)**	P_T	250 mW

TEMPERATURE

Storage	T_{stg}	-55 to 150°C
Operating	T_J	150°C
Lead, 1/16" ± 1/32" from case for 10 seconds maximum	T_L	260°C

*Determined from power limitations due to saturation voltage at this current.

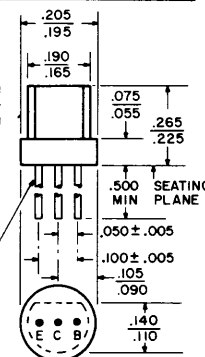
**Derate 2.88 mW/°C increase in ambient temperature between 25 and 150°C.

DIMENSIONS WITHIN
JEDEC OUTLINE TO-98

NOTE 1: Lead diameter is controlled in the zone between .070 and .250 from the seating plane. Between .250 and end of lead a max. of .021 is held.

ALL DIMEN. IN INCHES AND ARE
REFERENCE UNLESS TOLERANCED

3 LEADS
.017 +.002
-.001
(NOTE 1)



electrical characteristics: (25°C) (unless otherwise specified)

STATIC CHARACTERISTICS

Collector Cutoff Current

$V_{CB} = 40V, I_E = 0$	I_{CBO}	Min.	Typ.	Max.
			.0006	.5 μA

Emitter Cutoff Current

$V_{EB} = 5V, I_C = 0$	I_{EBO}	Min.	Typ.	Max.
			.004	.5 μA

Collector Cutoff Current

$V_{CE} = 40V, V_{BE} = 0$	I_{CES}	Min.	Typ.	Max.
			.001	.5 μA

Static Forward Current Transfer Ratio

$V_{CE} = 1V, I_C = 10 \text{ mA}$ 2N3973 & 75	h_{FE}	35		100
2N3974 & 76	h_{FE}	55		200
$V_{CE} = 1V, I_C = 150 \text{ mA}$ 2N3973 & 75	h_{FE}	30		
2N3974 & 76	h_{FE}	50		

Collector-Emitter Saturation Voltage

$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	$V_{CE(SAT)}$	Min.	Typ.	Max.
			.14	.3 Volts

Base-Emitter Saturation Voltage

$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	$V_{BE(SAT)}$	Min.	Typ.	Max.
			.9	1.3 Volts

Collector-Emitter Breakdown Voltage

$I_C = 10 \text{ mA}, I_B = 0$	BV_{CES}	40		Volts
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Collector-Base Breakdown Voltage

$I_C = 10 \mu A, I_E = 0$	BV_{CBO}	60		Volts
---------------------------	------------	----	--	-------

DYNAMIC CHARACTERISTICS

Collector Capacitance

$V_{CB} = 10V, I_E = 0, f = 1 \text{ MHz}^\ddagger$	C_{ob}	5.2		7 pF
---	----------	-----	--	------

Transition Capacitance

$V_{BE} = 0.5V, I_C = 0, f = 1 \text{ MHz}$	C_{ib}	20		pF
---	----------	----	--	----

Gain Bandwidth Product

$V_{CE} = 5V, I_C = 20 \text{ mA}, f_{meas.} = 100 \text{ MHz}$	f_t	200	350	MHz
---	-------	-----	-----	-----

Switching Times

$I_{B1} \approx I_{B2} \approx 10 \text{ mA}$ $I_C \approx 100 \text{ mA}$	t_{on}			60 nsec.
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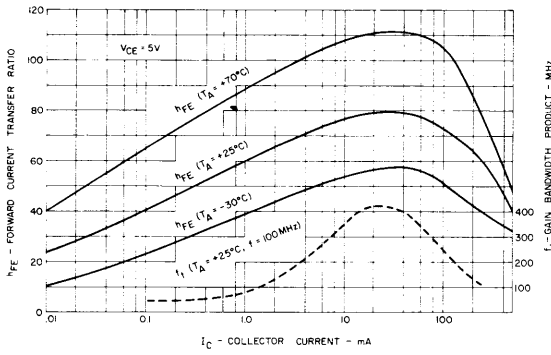
Turn-on Time

2N3973 & 74	t_{off}			110 nsec.
2N3975	t_{off}			200 nsec.
2N3976	t_{off}			250 nsec.

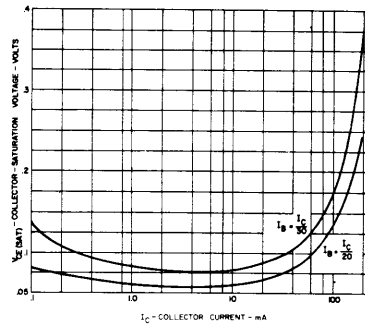
See Figure 1 for exact values.

‡ Hz is equivalent to cycles per second.

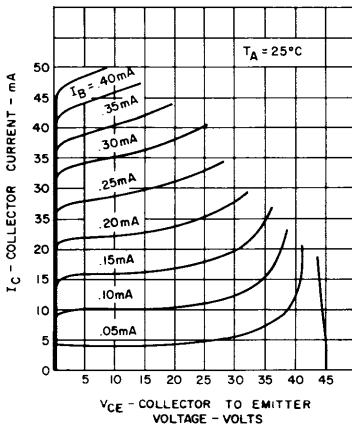
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)



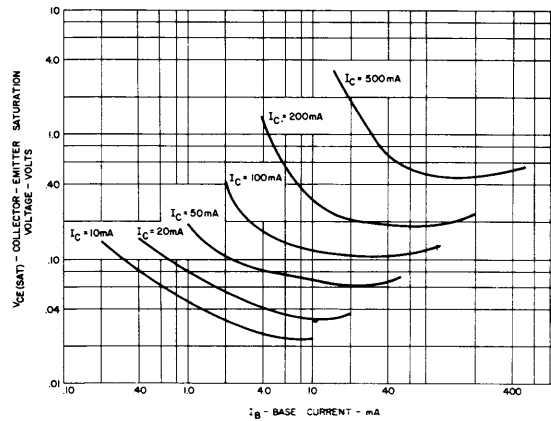
**Forward Current Transfer Ratio
and Gain Bandwidth Product
vs.
Collector Current**



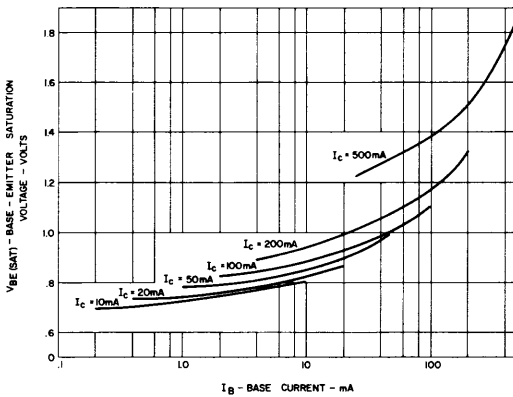
**Collector Saturation Voltage
vs.
Collector Current at $\beta = 20$ and 30**



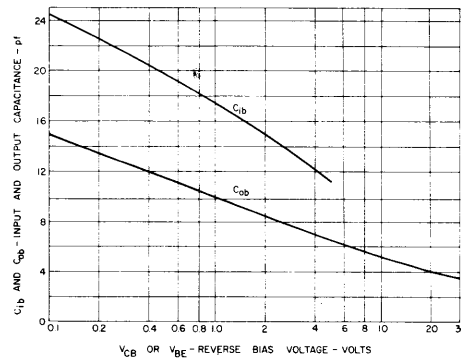
Collector Characteristics



**Collector Saturation Voltage
vs.
Base Current**



**Base Saturation Voltage
vs.
Base Current**



**Output Capacitance and
Input Capacitance
vs.
Voltage**

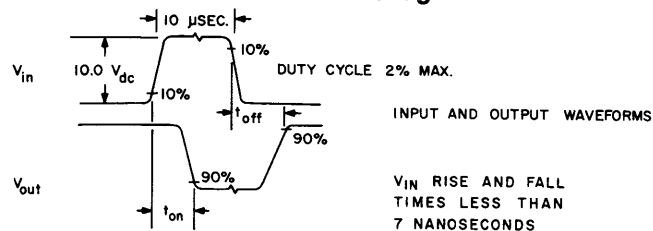
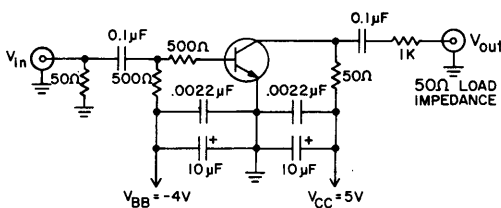


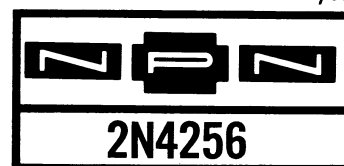
FIGURE 1

Printed in U.S.A.

Silicon Transistor

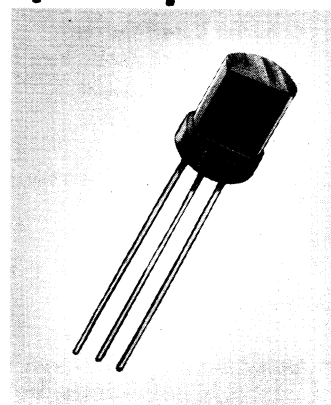
PLANAR EPITAXIAL PASSIVATED

45.46 5/66



13/07/02

The General Electric 2N4256 is a planar epitaxial, passivated NPN transistor characterized for low level medium speed switching applications in industrial circuits. This transistor features a high current transfer ratio over a wide range of collector current, a low collector saturation voltage, and a guaranteed stored base charge.



absolute maximum ratings: (25°C Unless Otherwise Specified)

Voltages

Collector to Emitter	V_{CES}	30 Volts
Emitter to Base	V_{EBO}	5 Volts
Collector to Base	V_{CBO}	30 Volts

- Low Cost
- High Beta
- Low $V_{CE(SAT)}$
- Rugged Encapsulation

Current

Collector (Steady State)*	I_C	100 mA
---------------------------	-------	--------

Dissipation

Total Power (Free air at 25°C) † P_T	200 mW
Total Power (Free air at 55°C) † P_T	120 mW

Temperature

Storage	T_{STG}	-55 to 125°C
Operating	T_J	100°C
Lead Soldering, 1/16" ± 1/32" from case for 10 sec. max.	T_L	260°C

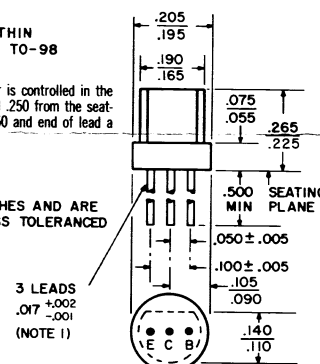
*Determined from power limitations due to saturation voltage at this current.

†Derate 2.67 mW/°C increase in ambient temperature above 25°C.

DIMENSIONS WITHIN
JEDEC OUTLINE TO-98

NOTE 1: Lead diameter is controlled in the zone between .070 and .250 from the seating plane. Between .250 and end of lead a max. of .021 is held.

ALL DIMEN. IN INCHES AND ARE
REFERENCE UNLESS TOLERANCED



electrical characteristics (25°C Unless Otherwise Specified)

STATIC CHARACTERISTICS

		Min.	Typ.	Max.	Units
Collector to Base Breakdown Voltage ($I_C = 100\mu A$)	V_{CBO}	30			V
Collector to Emitter Breakdown Voltage ($V_{EB} = 0, I_C = 1mA$)	V_{CES}	30			V
Emitter to Base Breakdown Voltage ($I_E = 100\mu A$)	V_{EBO}	5			V
Forward Current Transfer Ratio ($I_C = 2mA, V_{CE} = 4.5V$)	h_{FE}	100	220	500	
Forward Current Transfer Ratio ($I_C = 10mA, V_{CE} = 0.2V$)	h_{FE}	60	120		
Forward Current Transfer Ratio ($I_C = 50mA, V_{CE} = 0.2V$)	h_{FE}	20			

STATIC CHARACTERISTICS

Collector-Emitter Saturation Voltage

($I_C = 0.1$ to 10mA , $I_B = I_C/50$)

$V_{CE(SAT)}$

Min.

Typ.

Max.

Units

0.16

0.20

V

Collector-Emitter Saturation Voltage

($I_C = 50\text{mA}$, $I_B = 2.5\text{mA}$)

$V_{CE(SAT)}$

0.14

0.20

V

Base-Emitter Saturation Voltage

($I_C = 50\text{mA}$, $I_B = 2.5\text{mA}$)

$V_{BE(SAT)}$

0.82

0.92

V

Collector Cutoff Current

($V_{CB} = 30\text{V}$)

I_{CBO}

0.1

500

nA

Collector Cutoff Current

($V_{CB} = 18\text{V}$, $T_A = 100^\circ\text{C}$)

I_{CBO}

15

μA

Collector Cutoff Current

($V_{CE} = 30\text{V}$, $V_{EB} = 0$)

I_{CES}

0.1

500

nA

Emitter Cutoff Current

($V_{EB} = 5\text{V}$)

I_{EBO}

0.1

500

nA

DYNAMIC CHARACTERISTICS

Collector Capacitance

($V_{CB} = 10\text{V}$, $I_E = 0$, $f = 1\text{MHz}$)

C_{ob}

2.7

4.0

pF

Transition Capacitance

($V_{EB} = 0.5\text{V}$, $I_C = 0$, $f = 1\text{MHz}$)

C_{ib}

10

pF

Stored Base Charge (Circuit 1)

($I_B = 0.32\text{mA}$, $I_C = 10\text{mA}$)

Q_{SB}

250

600

pC

Gain Bandwidth product

($V_{CE} = 1\text{V}$, $I_C = 10\text{mA}$)

f_T

200

MHz

Turn-on Time (Figure 1)

($I_C = 10\text{mA}$)

t_{on}

4.0

nS

Turn-off Time (Figure 1)

($I_C = 10\text{mA}$)

t_{off}

40

100

nS

Turn-on Time (Figure 2)

($I_C = 10\text{mA}$, $I_{B1} = 0.32\text{mA}$,
 $I_{B2} = 54\mu\text{A}$)

t_{on}

180

nS

Turn-off Time (Figure 2)

($I_C = 10\text{mA}$, $I_{B1} = 0.32\text{mA}$,
 $I_{B2} = 54\mu\text{A}$)

t_{off}

2.5

3.5

μS

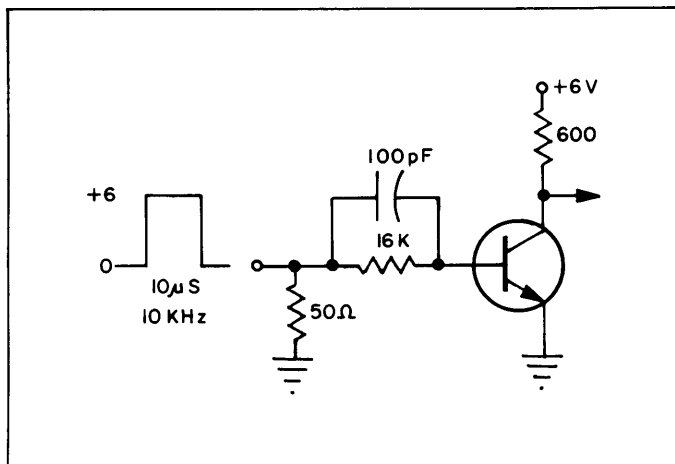


Figure 1

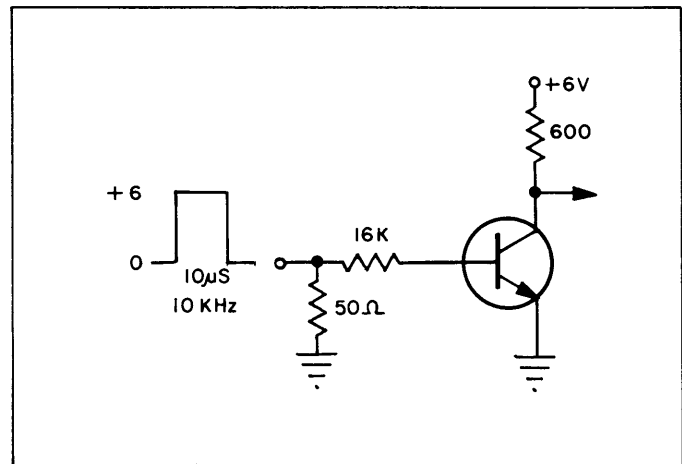
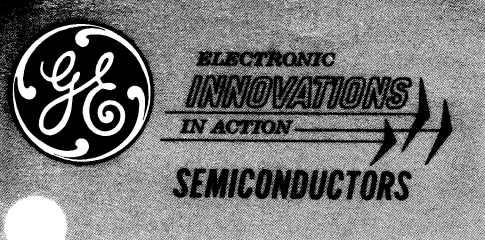


Figure 2

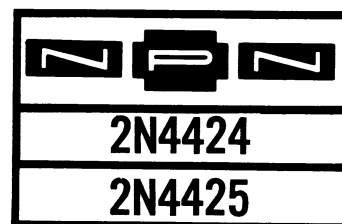
Q_{SB} measured in circuit of Figure 1, the capacitor is adjusted to give a turn off time of 100nS, and Q_{SB} is calculated from the equation $Q_{SB} = 6C$.



Silicon Consumer — Industrial Transistors

PLANAR EPITAXIAL PASSIVATED

40.19 2/68



The General Electric 2N4424 and 2N4425 types are NPN, silicon, planar, passivated, epitaxial transistors intended for general purpose industrial circuits. These transistors are especially suited for high level linear amplifiers or medium speed switching circuits in industrial control applications.

FEATURES:

Low Saturation Voltage

High Beta

900 mW @ 25°C Case

360 mW @ 25°C Free Air

2N4425

2N4424

absolute maximum ratings: (25°C) (unless otherwise specified)

Voltages

Collector to Emitter

Emitter to Base

Collector to Base

V_{CEO}	40	40	V
V_{EBO}	5	5	V
V_{CBO}	60	60	V

Current

Collector (Steady State)*

I_C	500	500	mA
-------	-----	-----	----

Dissipation

Total Power (Free Air at 25°C)**

Total Power (Free Air at 65°C)**

Total Power (Heatsink at 25°C)***

P_T	360	560	mW
P_T	250	380	mW
P_T	—	900	mW

Temperature

Storage

Operating

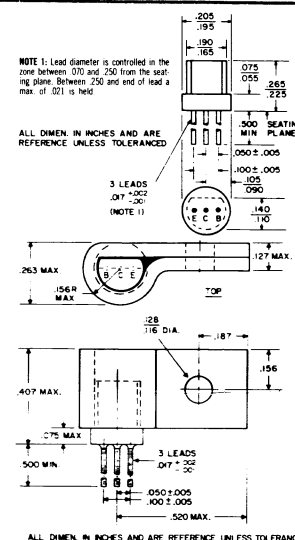
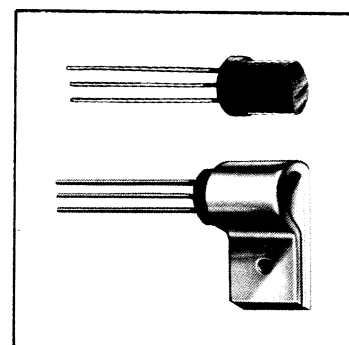
Lead soldering, $\frac{1}{16}$ " $\pm$ $\frac{1}{32}$ " from case
for 10 sec. max.

T_{stg}	-55 to +150	°C
T_j	+150	°C
T_L	+260	°C

*Determined from power limitations due to saturation voltage at this current.

**Derate 2.88mW/°C increase in ambient temperature above 25°C.

***Derate 7.2 mW/°C for rise in heatsink temperature above 25°C.



electrical characteristics: (25°C) (unless otherwise specified)

DC CHARACTERISTICS

		Min.	Max.	
Collector Cutoff Current ($V_{CB} = 40V$)	I_{CBO}		30	nA
	I_{CBO}		10	μA
	I_{CES}		30	nA
Emitter Cutoff Current ($V_{EB} = 5V$)	I_{EBO}		100	nA
Forward Current Transfer Ratio ($V_{CE} = 4.5V, I_C = 2 mA$)	h_{FE}	180	540	
	$V_{(BR)CEO}$	40		V
Collector Emitter Breakdown Voltage ($I_C = 10 mA$)	$V_{(BR)CEO}$	60		V
Collector Base Breakdown Voltage ($I_C = 10 \mu A$)	$V_{(BR)CBO}$	5		V
Emitter Base Breakdown Voltage ($I_E = 0.1 \mu A$)	$V_{(BR)EBO}$			V
Collector Saturation Voltage ($I_B = 3 mA, I_C = 50 mA$)	$V_{CE(sat)}$		.30	V
Base Saturation Voltage ($I_B = 3 mA, I_C = 50 mA$)	$V_{BE(sat)}$		.85	V

SMALL SIGNAL CHARACTERISTICS

Forward Current Transfer Ratio Collector Voltage
($V_C = 4.5V, I_C = 2 mA, f = 1 kHz$)

h_{re}	180
----------	-----

Forward Current Transfer Ratio

Input Impedance

Output Admittance

Voltage Feedback Ratio

($V_{CE} = 10V, I_C = 1 mA,$
 $f = 1 kHz, T_A = 25^\circ C$)

h_{re}

h_{ie}

h_{oe}

h_{re}

Typical

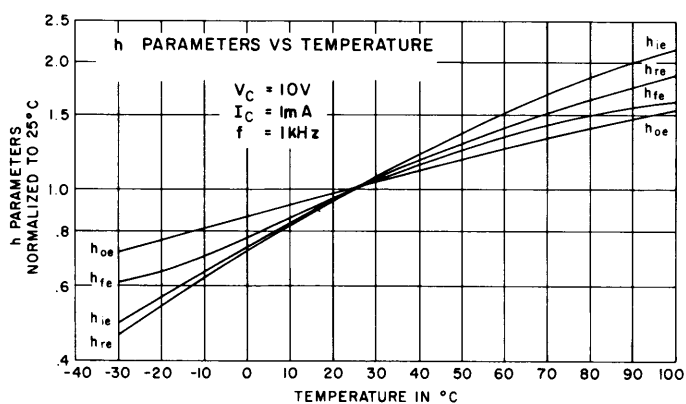
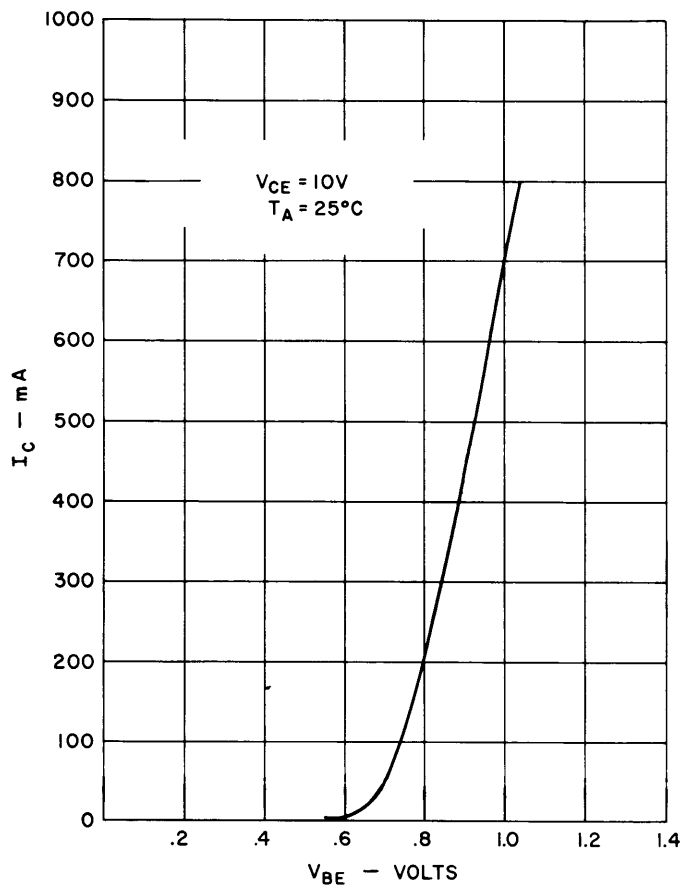
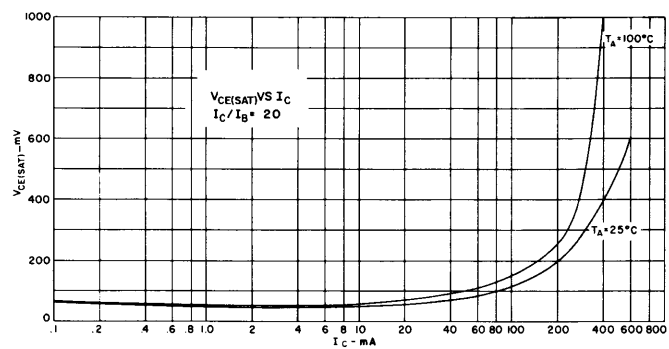
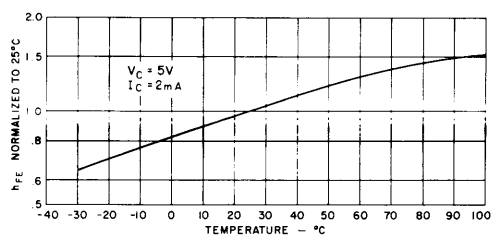
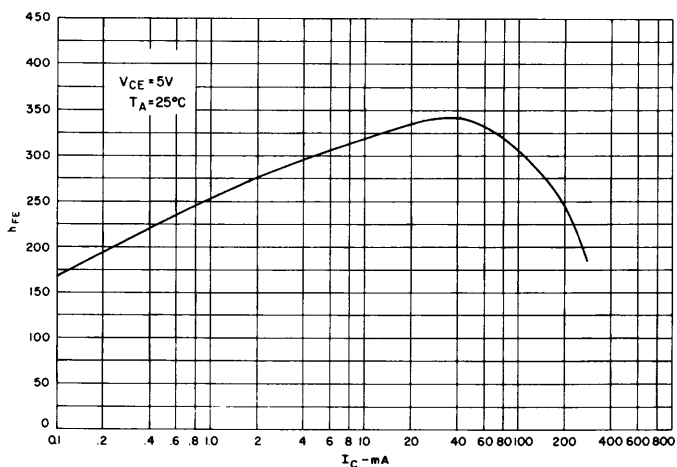
180

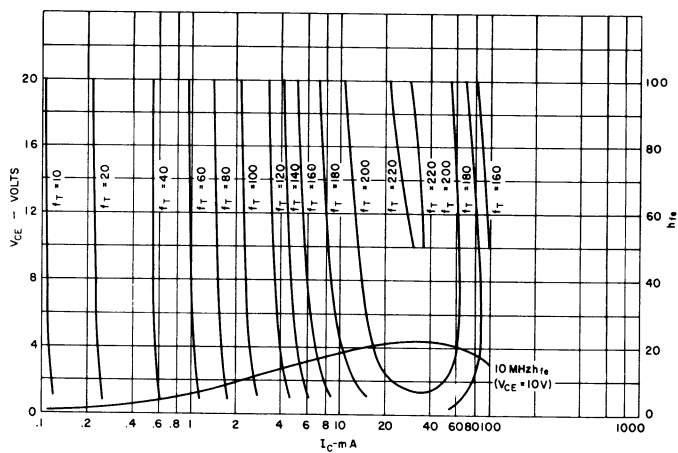
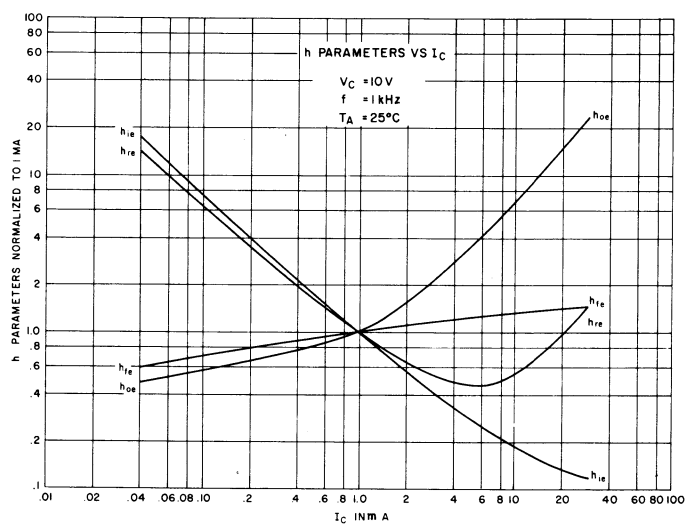
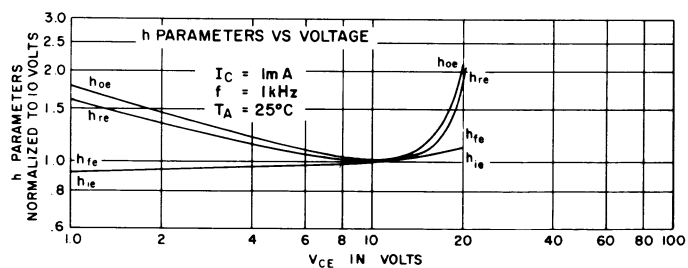
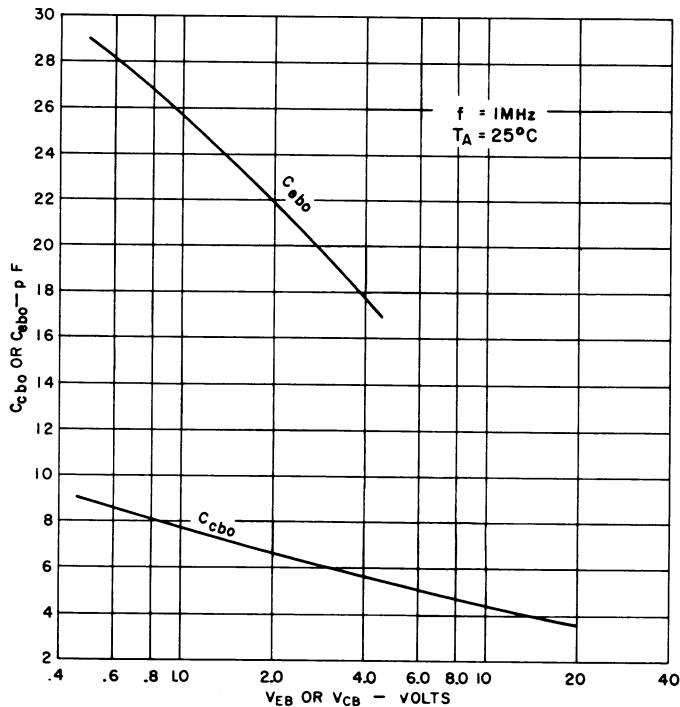
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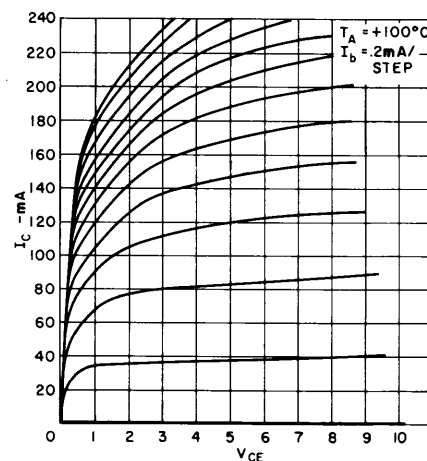
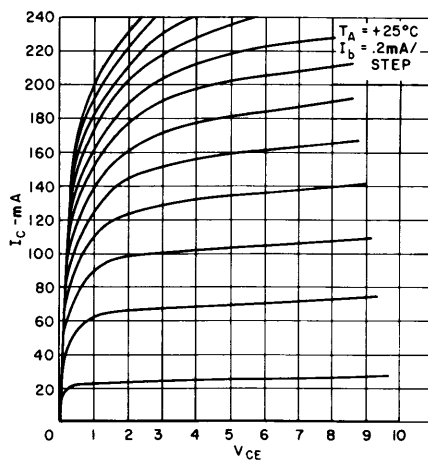
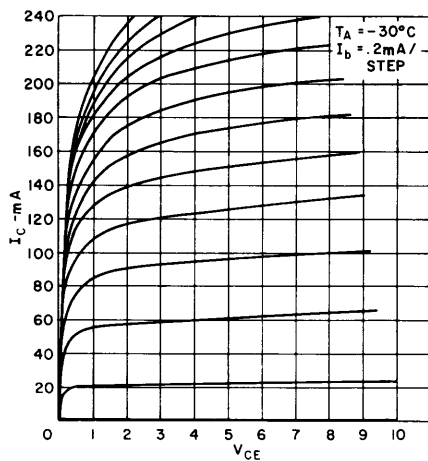
14

.27

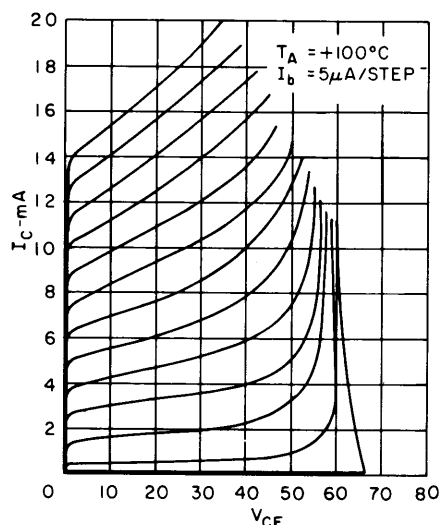
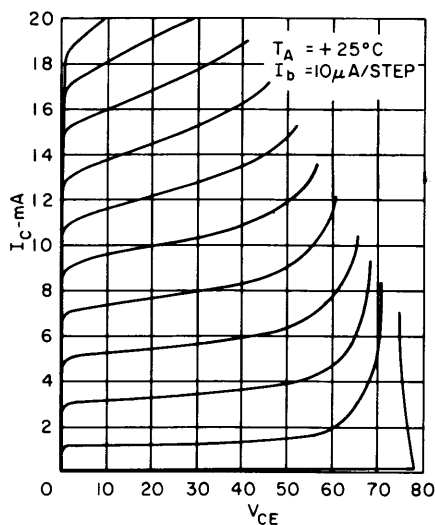
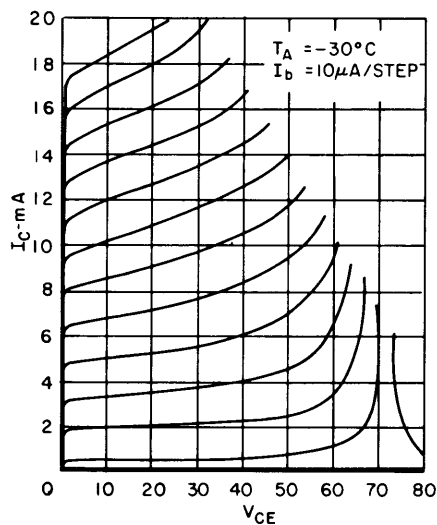
ohms
 $\mu mhos$
 $\times 10^{-3}$





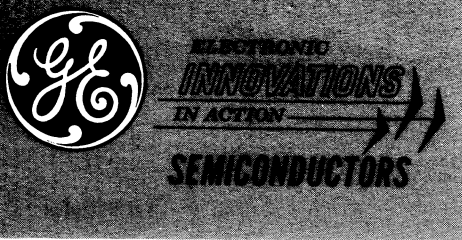


Typical Common Emitter Current Characteristic Curves



Typical Common Emitter Characteristic Curves

PRINTED IN U.S.A.



8 Micron
13/0 7/02
TRANSISTORS

40.14 9/67

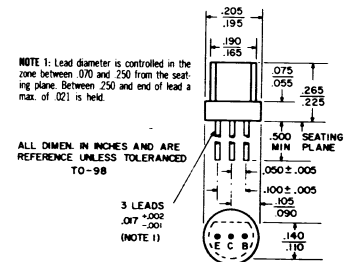
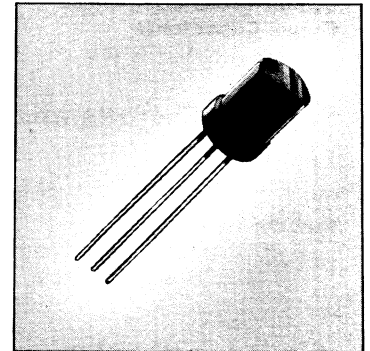
PLANAR EPITAXIAL PASSIVATED

2N4951
2N4952
2N4953
2N4954

The General Electric 2N4951-2N4954 are silicon NPN planar passivated epitaxial devices intended for high speed switching, amplifier, and core driver applications. The devices feature excellent switching speeds and low collector saturation voltages up to the maximum current rating. These epoxy encapsulated units are electrically equivalent to the 2N2220-22 series.

absolute maximum ratings: (25°) (unless otherwise specified)

Voltages		2N4951-3	2N4954	
Collector to Base	V_{CBO}	60	40	Volts
Collector to Emitter*	V_{CEO}	30	30	Volts
Emitter to Base	V_{EBO}	5	5	Volts
Current				
Collector	I_C	500	500	mA
Dissipation				
Total Power†	P_T	360	360	mW
Temperature				
Storage	T_{stg}	-55 to +150°C		
Operating Junction	T_J	+150°C		
Lead (1/16" from case for 10 seconds)		+260°C		



*This value applies when the Base-Emitter diode is open-circuited.

†Derate linearly to 150°C free-air temperature at the rate of 2.87 mW/°C.

electrical characteristics: (25°) (unless otherwise specified)

		2N4951		2N4952		2N4953		2N4954	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
Collector to Base Breakdown Voltage ($I_C = 10 \mu A, I_E = 0$)		$V_{(BR)CBO}$	60	60		60		40	Volts
Collector to Emitter Breakdown Voltage ($I_C = 10 \text{ mA}, I_B = 0$) ‡		$V_{(BR)CEO}$	30	30		30		30	Volts
Emitter to Base Breakdown Voltage ($I_E = 10 \mu A, I_C = 0$)		$V_{(BR)EBO}$	5	5		5		5	Volts
Collector Cutoff Current ($V_{CB} = 40V, I_E = 0$) ($V_{CB} = 30V, I_E = 0$)		I_{CBO} I_{CBO}	50	50		50		50	nA nA
Emitter Cutoff Current ($V_{EB} = 3V, I_C = 0$)		I_{EBO}	50	50		50		500	nA
Static Forward Current Transfer Ratio ($I_C = 1 \text{ mA}, V_{CE} = 10V$) ($I_C = 10 \text{ mA}, V_{CE} = 10V$) ‡ ($I_C = 150 \text{ mA}, V_{CE} = 10V$) ‡		h_{FE} h_{FE} h_{FE}	20 40 60	50 75 100	200	75 150 200	600	20 40 60	600

‡Pulse test: Pulse width = 300 μ sec, duty cycle $\leq 2\%$.

		2N4951, 2, 3, 4	
		Min.	Max.
Base to Emitter Voltage ($I_C = 150 \text{ mA}$, $V_{CE} = 10 \text{ V}$)‡	V_{BE}		1.2 Volts
Base to Emitter Saturation Voltage ($I_C = 150 \text{ mA}$, $I_B = 15 \text{ mA}$)‡	$V_{BE(sat)}$		1.3 Volts
Collector to Emitter Saturation Voltage ($I_C = 150 \text{ mA}$, $I_B = 15 \text{ mA}$)‡	$V_{CE(sat)}$		0.3 Volts
Small-Signal Common-Emitter Forward Current Transfer Ratio ($I_C = 20 \text{ mA}$, $V_{CE} = 10 \text{ V}$, $f = 100 \text{ MHz}$)	$ h_{fe} $	2.5	
Common-Base Open-Circuit Output Capacitance ($I_E = 0$, $V_{CB} = 10 \text{ V}$, $f = 1 \text{ MHz}$)	C_{cb}		8 pF
Switching Characteristics			
Turn-On Time ($I_C = 150 \text{ mA}$, $V_{CC} = 30 \text{ V}$, $I_{B1} = 15 \text{ mA}$, Figure 1)	t_{on}		40 nsec
Turn-Off Time ($I_C = 150 \text{ mA}$, $V_{CC} = 30 \text{ V}$, $I_{B1} = -I_{B2} = 15 \text{ mA}$, Figure 2)	t_{off}		350 nsec
	t_{off}		400 nsec

‡Pulse test: Pulse Width = 300 μsec , duty cycle $\leq 2\%$.

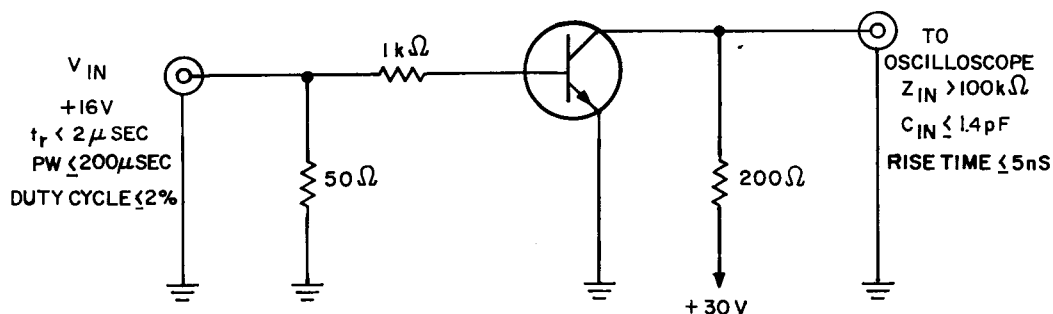


FIGURE 1. TEST CIRCUIT FOR DETERMINING TURN-ON TIME

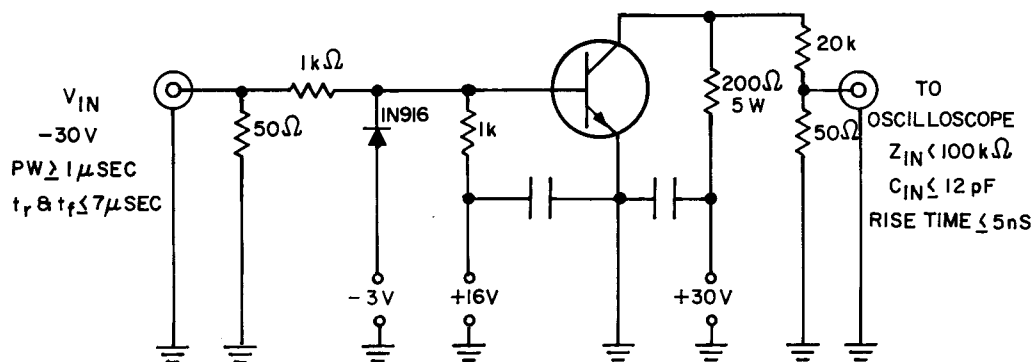


FIGURE 2. TEST CIRCUIT FOR DETERMINING TURN-OFF TIME

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